

Super Low Dross™ Solder Bar Sn63/Pb37 0.5lb (227g) Extruded

Product Highlights

Extruded High Reliability Solder Bar
 Manufactured Specifically for High Quality Electronics Manufacturing (EMS, ECM, OEMs)
 Designed for Solder Pots, Wave Solder Machines and Selective Solder Machines
 Chip Quik® Super Low Dross™ Solder Bar is Ideal for Through Hole and Surface Mount Soldering
 High Purity



Specifications

Alloy: Sn63/Pb37
 Melting Point: 183°C (361°F)
 Packaging: 0.5 lb (227 +/-20 g) bar (Ships bagged. To ensure weight tolerance is met: Full bar and/or fractional bar segments may be combined in each bag.)
 Shelf Life: Indefinite

Purity

Element	IPC J-STD-006C	ChipQuik® Super Low Dross™ BARSN63PB37
Silver (Ag)	0.100 %	< 0.100 %
Aluminum (Al)	0.005 %	< 0.005 %
Arsenic (As)	0.030 %	< 0.030 %
Gold (Au)	0.050 %	< 0.050 %
Bismuth (Bi)	0.100 %	< 0.100 %
Cadmium (Cd)	0.002 %	< 0.002 %
Copper (Cu)	0.080 %	< 0.080 %
Iron (Fe)	0.020 %	< 0.020 %
Indium (In)	0.100 %	< 0.100 %
Nickel (Ni)	0.010 %	< 0.010 %
Lead (Pb)	0.070 %	37.000 %
Tin (Sn)	0.250 %	63.000 %
Zinc (Zn)	0.003 %	< 0.003 %
Antimony (Sb)	0.200 %	< 0.200 %

Tolerances: +/-0.100% (Composition ≤ 1.000%), +/-0.200% (1.000% < Composition ≤ 5.000%), +/-0.500% (Composition > 5.000%)

Storage and Handling

Store in a dry non-corrosive environment.

Transportation

This product has no shipping restrictions.

Test Results

Test J-STD-004 or other requirements as stated	Test Requirement	Result
Conflict Minerals Compliance	Electronic Industry Citizenship Coalition (EICC)	Compliant
REACH Compliance	Articles 33 and 67 of Regulation (EC) No 1907/2006	Contains Lead (Pb) CAS# 7439-92-1 No other SVHC present

Conforms to the following Industry Standards:

J-STD-006C, Amendments 1 & 2 (Solder Alloys and Fluxed/Non-Fluxed Solders): Yes
 RoHS 3 Directive (EU) 2015/863: No [Contains Lead (Pb)]